

http://www.orientdisplay.com

SPECIFICATION FOR TFT MODULE

MODULE NO: AFY800480B0-5.0N12NTM-R REVISION NO: A

Customer's Approval:

| | SIGNATURE | DATE |
|---------------------------|-----------|------|
| PREPARED BY (RD ENGINEER) | | |
| CHECKED BY | | |
| APPROVED BY | | |

REVISION RECORD

| Rev date | Contents | Remarks |
|------------|------------------------|--------------------------|
| 2016-03-10 | First release | Preliminary |
| 2017-05-25 | Update TBD information | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | | |
| | 2016-03-10 | 2016-03-10 First release |

CONTENTS

| 1. GENERAL INFORMATION | 1 |
|------------------------------------|---|
| 2. ABSOLUTE MAXIMUM RATINGS | 1 |
| 3. ELECTRICAL CHARACTERISTICS | 1 |
| 4. BACKLIGHT CHARACTERISTICS | 1 |
| 5. TOUCH PANEL CHARACTERISTICS | 5 |
| 6. EXTERNAL DIMENSIONS | 5 |
| 7. ELECTRO-OPTICAL CHARACTERISTICS | 7 |
| 3. INTERFACE DESCRIPTION | 9 |
| 9. AC CHARACTERISTICS 10 |) |
| 10. POWER SEQUENCE | 3 |
| 11. RELIABILITY TEST CONDITIONS 14 | 1 |
| 12. INSPECTION CRITERION | 5 |
| 13. HANDLING PRECAUTIONS23 | 3 |
| 14. PRECAUTION FOR USE24 | 1 |
| 15. PACKING SPECIFICATION24 | 1 |

1. GENERAL INFORMATION

| No. | Item | Contents | Unit |
|-----|--------------------------------|--|------|
| 1 | LCD size | 5.0 inch (Diagonal) | / |
| 2 | LCD type | TN/Normally white/Transmissive(Anti-glare) | / |
| 3 | Viewing direction(eye) | 12 O'clock | / |
| 4 | Gray scale inversion direction | 6 O'clock | / |
| 5 | Resolution(H*V) | 800 *480 Pixels | / |
| 6 | Module size (L*W*H) | 120.70*75.80*3.95 | mm |
| 7 | Active area (L*W) | 108.00*64.80 | mm |
| 8 | Pixel pitch (L*W) | 0.135*0.135 | mm |
| 9 | Interface type | RGB interface | / |
| 10 | Module power consumption | 1.274(with backlight) | W |
| 11 | Back light type | LED | / |
| 12 | Driver IC | ILI6122+ILI5960 OR COMPATIBLE | / |
| 13 | Weight | 74.6 | g |

2. ABSOLUTE MAXIMUM RATINGS

| Item | Symbol | Min. | Max. | Unit |
|--|--------|------|---------------|------|
| Power supply input voltage(TFT Module) | VDD | -0.3 | 5.0 | V |
| Backlight current (normal temp.) | ILED | - | 50 | mA |
| Operation temperature | Тор | -20 | 70 | °C |
| Storage temperature | Tst | -30 | 80 | °C |
| Humidity | RH | - | 90%(Max60 °C) | RH |

3. ELECTRICAL CHARACTERISTICS DC CHARACTERISTICS(at Ta=25°C)

| Item | Symbol | Min. | Тур. | Max. | Unit | Note |
|--|--------|---------|-------|---------|------|------|
| Power supply input voltage(TFT Module) | VDD | 3.0 | 3.3 | 3.6 | V | |
| I/O logic voltage | VDDIO | N/A | N/A | N/A | V | |
| Input voltage 'H' level | VIH | 0.7VDDI | - | VDDI | V | |
| Input voltage 'L' level | VIL | VSS | - | 0.3VDDI | V | |
| Power supply current | IVDD | - | 127.2 | - | mA | |
| TFT gate on voltage | VGH | - | N/A | - | V | |
| TFT gate off voltage | VGL | - | N/A | - | V | |
| Analog power supply voltage | AVDD | - | N/A | - | V | |
| Differential input common mode voltage | Vcom | - | N/A | - | V | |

4. BACKLIGHT CHARACTERISTICS

(at Ta=25°C,RH=60%)

| Item | Symbol | Min. | Тур. | Max. | Unit | Note |
|-----------------------|--------|--------|---------------|------|------|-----------|
| LED forward voltage | VF | - | 18.6 | 19.8 | V | IF=20*2mA |
| LED forward current | IF | - | 40 | - | mA | |
| LED power consumption | PLED | - | 0.744 | - | W | Note1 |
| Number of LED | - | | 12 | | PCS | |
| Connection mode | - | 6 in s | eries 2 in pa | / | | |
| LED life-time | - | 20000 | - | - | Hrs | Note2 |

Note1 : Calculator value for reference : $IF^*VF = PLED$

Note2 : The LED life-time define as the estimated time to 50% degradation of initial brightness at Ta=25°C and IF =40mA. The LED lifetime could be decreased if operating IF is larger than 40mA.

5. TOUCH PANEL CHARACTERISTICS

(at Ta=25°C)

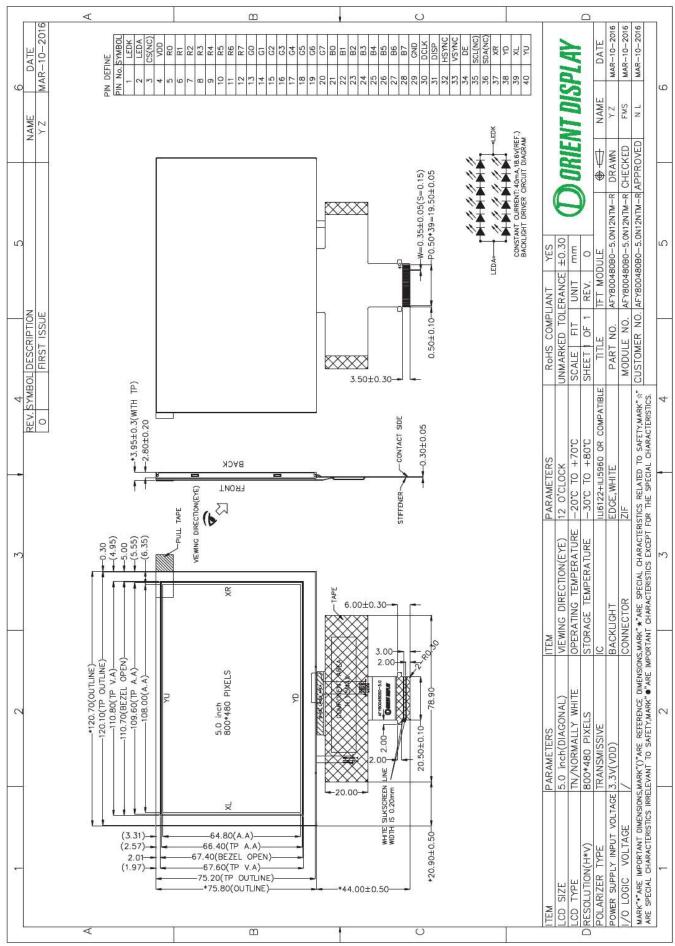
| FPC Design | Item | Description | Note |
|------------|-------------------------|-------------|------|
| | IC solution on TP Model | - | |
| | Touch Count Max | - | |
| | Display Resolution* | - | |
| [√] COF | Interface Type * | - | |
| | I2C Slave Address* | - | |
| | Origin of Coordinate* | - | |
| | IC solution on Broad* | - | |
| [] COB | Driving Channels | - | |
| | Sensing Channels | - | |

| Parameter | Min. | Тур. | Max. | Unit |
|---------------------------|------|------|------|------|
| Interface Signal Voltage* | - | - | - | V |
| Power Voltage* | - | - | - | V |
| Power ripple* | - | - | - | MV |

Note1 : The detail refer to the Specification For IC.

Note2 : "*" means that the item is optional according to the product requirement.

6. EXTERNAL DIMENSIONS



AFY800480B0-5.0N12NTM-R

| Item | Symbol | Condition | Min. | Тур. | Max. | Unit | Remark | Note |
|-------------------------|---------|-----------------|--------|--------|--------|-------------------|---------|--------|
| Response time | Tr+ Tf | | - | 25 | 50 | ms | FIG.1 | Note 4 |
| Contrast ratio | Cr | - | 400 | 500 | - | - | FIG.2 | Note 1 |
| Surface Iuminance | Lv | θ=0° | 300 | 380 | - | cd/m ² | FIG.2 | Note 2 |
| Luminance uniformity | Yu | θ=0° | 75 | 80 | - | % | FIG.2 | Note 3 |
| NTSC | - | θ=0° | - | 50 | - | % | FIG.2 | Note 5 |
| | | Ø =90° | 60 | 70 | - | deg | FIG.3 | |
| | θ | Ø =270° | 40 | 50 | - | deg | FIG.3 | Note 6 |
| Viewing angle | Ð | Ø=0° | 60 | 70 | - | deg | FIG.3 | Note 6 |
| | | Ø=180° | 60 | 70 | - | deg | FIG.3 | |
| | Red x | | 0.5249 | 0.5649 | 0.6049 | - | | |
| | Red y | | 0.2985 | 0.3385 | 0.3785 | - | | |
| | Green x | | 0.3050 | 0.3450 | 0.3850 | - | | |
| CIE (x,y) | Green y | θ=0° | 0.5369 | 0.5769 | 0.6169 | - | FIG.2 | Nata E |
| chromaticity | Blue x | Ø=0° Ta=25°C | 0.1086 | 0.1486 | 0.1886 | - | CIE1931 | Note 5 |
| | Blue y | 10-20 0 | 0.0572 | 0.0972 | 0.1372 | - | | |
| | White x | | 0.2743 | 0.3143 | 0.3543 | - | | |
| | White y | | 0.3026 | 0.3426 | 0.3826 | - | | |

7. ELECTRO-OPTICAL CHARACTERISTICS

Note1.Definition of contrast ratio

Contrast ratio(Cr) is defined mathematically by the following formula.

For more information see FIG.2.

Contrast ratio= <u>Luminance measured when LCD on the "White" state</u> Luminance measured when LCD on the "Black" state

Measured at the center area of the LCD

Note2.Definition of surface luminance

Surface luminance is the luminance with all pixels displaying white.

For more information see FIG.2.

Lv = Average Surface Luminance with all white pixels(P1,P2,P3,,Pn)

Note3.Definition of luminance uniformity

The luminance uniformity in surface luminance is determined by measuring luminance at each test position 1 through n, and then dividing the maximum luminance of n points luminance by minimum luminance of n points luminance.For more information see FIG.2.

Minimum surface luminance with all white pixels (P1,P2,P3,.....,Pn) Yu =

Maximum surface luminance with all white pixels (P1,P2,P3,.....,Pn)

Note4. Definition of response time

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time (T_{ON}) is the time between photo detector output intensity changed from 90% to 10%. And fall time (T_{OFF}) is the time between photo detector output intensity changed from 10% to 90%. For additional information see FIG1.

Note5. Definition of color chromaticity (CIE1931)

CIE (x,y) chromaticity, The x,y value is determined by screen active area center position P5. For more information see FIG.2.

Note6. Definition of viewing angle

Viewing angle is the angle at which the contrast ratio is greater than 10. angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG.3.

For viewing angle and response time testing, the testing data is base on Autronic-Melchers's ConoScope or DMS series Instruments or compatible. For contrast ratio, Surface Luminance, Luminance uniformity and CIE, the testing data is base on TOPCON's BM-5or BM-7 photo detector or compatible.

Note: For TFT module, Gray scale reverse occurs in the direction of panel viewing angle.

FIG.1. The definition of response Time

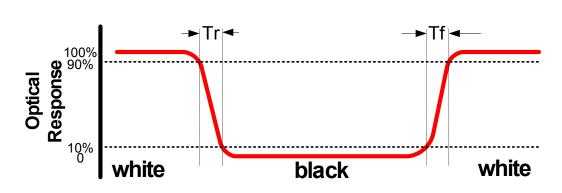
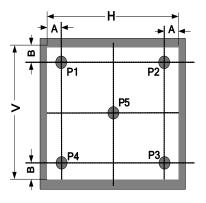
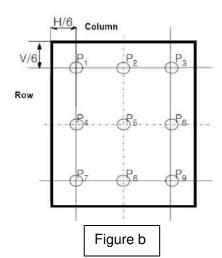


FIG.2. Measuring method for contrast ratio, surface luminance, luminance uniformity, CIE (x,y) chromaticity

Size : $S \le 5$ "(see Figure a) A : 5 mm B : 5 mm H,V : Active area Light spot size $\emptyset = 5$ mm(BM-5) or $\emptyset = 7.7$ mm (BM-7)50cm distance or compatible distance from the LCD surface to detector lens. test spot position : see Figure a. measurement instrument : TOPCON's luminance meter BM-5 or BM-7 or compatible (see Figure c).







Size : 5" < S≤12.3"(see Figure b) H,V : Active area

Light spot size \emptyset =5mm(BM-5) or \emptyset =7.7mm (BM-7)50cm distance or compatible distance from the LCD surface to detector lens. test spot position : see Figure b.

measurement instrument : TOPCON's luminance meter BM-5 or BM-7 or compatible (see Figure c).

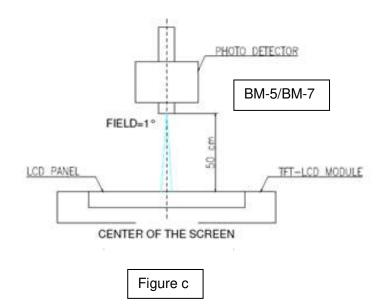
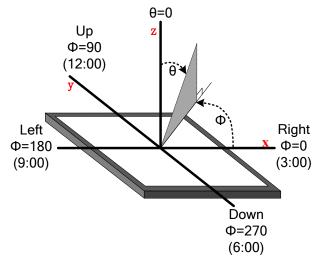


FIG.3. The definition of viewing angle



8. INTERFACE DESCRIPTION

| TFT Module Inter Interface No. | Name | I/O or connect to | Description |
|-----------------------------------|------------|-------------------|----------------------------------|
| 1 | LEDK | Р | Power for LED backlight(Cathode) |
| 2 | LEDA | Р | Power for LED backlight(Anode) |
| 3 | CS(NC) | / | No connection |
| 4 | VDD | Р | Power for LCD |
| 5-12 | Red(0-7) | I | Red data signal |
| 13-20 | Green(0-7) | I | Green data signal |
| 21-28 | Blue(0-7) | I | Blue data signal |
| 29 | GND | I | Ground |
| 30 | DCLK | I | Dot clock signal |
| 31 | DISP | I | Display on/off |
| 32 | HSYNC | I | Horizontal sync input. |
| 33 | VSYNC | I | Vertical sync input |
| 34 | DE | I | Data enable |
| 35 | SCL(NC) | / | No connection |
| 36 | SDA(NC) | / | No connection |
| 37 | XR | I | TP:X right |
| 38 | YD | I | TP:Y bottom |
| 39 | XL | I | TP:X left |
| 40 | YU | I | TP:Y top |

9. AC CHARACTERISTICS

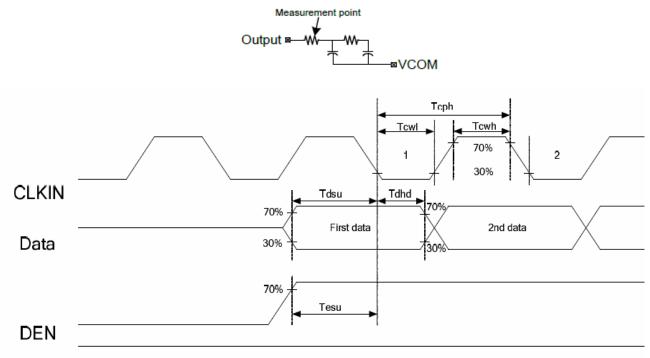
| Parameter | Symbol | | Spec | | Unit | Conditions | |
|--------------------------------|-------------------|------|------|------|-------|------------------------------------|--|
| | Symbol | Min. | Typ. | Max. | Onic | | |
| VDD Power ON slew rate | t _{POR} | | | 20 | ms | 0V ~ 0.9VDD | |
| RSTB pulse width | t _{RST} | 10 | | | us | CLKIN=50MHz | |
| CLKIN cycle time | t _{CPH} | 20 | | | ns | | |
| CLKIN pulse duty | t _{cwH} | 40 | 50 | 60 | % | | |
| VSD setup time | t _{vst} | 8 | 1 | | ns | | |
| VSD hold time | t _{VHD} | 8 | | | ns | | |
| HSD setup time | t _{HST} | 8 | | - | ns | | |
| HSD hold time | t _{HHD} | 8 | | - | ns | | |
| Data setup time | t _{DST} | 8 | | - | ns | D0[7:0], D1[7:0], D2[7:0] to CLKIN | |
| Data hold time | t _{DHD} | 8 | | | ns | D0[7:0], D1[7:0], D2[7:0] to CLKIN | |
| DE setup time | t _{EST} | 8 | | | ns | | |
| DE hold time | t _{ehd} | 8 | | | ns | | |
| Output stable time | V | | | 6 | | 10% to 90% target voltage. | |
| Output stable time | ISST | | | 0 | us | CL=120pF, R=10KΩ | |
| CLKIN frequency | ✓f _{CLK} | | 40 | 50 | MHz | VDD=3.0 ~ 3.6V | |
| CLKIN cycle time | t _{cLK} | 20 | 25 | | ns | | |
| CLKIN pulse duty | t _{cwн} | 40 | 50 | 60 | % | Тсік | |
| Time from HSD to Source output | t _{HSO} | | 20 | | CLKIN | | |
| Time from HSD to LD | t _{HLD} | | 20 | | CLKIN | Note (2) | |
| Time from HSD to STV | t _{HSTV} | | 2 | | CLKIN | | |
| Time from HSD to CKV | t _{HCKV} | | 20 | | CLKIN | | |
| Time from HSD to OEV | t _{HOEV} | | 4 | | CLKIN | | |
| LD pulse width | t _{WLD} | | 10 | | CLKIN | Note (2) | |
| CKV pulse width | t _{wckv} | | 66 | | CLKIN | | |
| OEV pulse width | twoev | | 74 | | CLKIN | | |
| | | | | | | | |

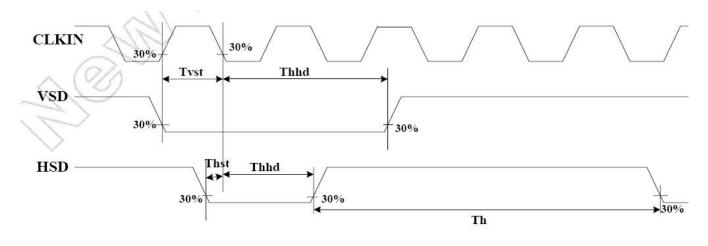
Note: (1) VDD=3.0 ~ 3.6V, VDDA=6.5~13.5V, DGND=AGND=0V, Ta=-20~+85 °C

(2) The contents of the data register are transferred to the latch circuit at the rising edge of LD. Then the

gray scale voltage is output from the device at the falling edge of LD.

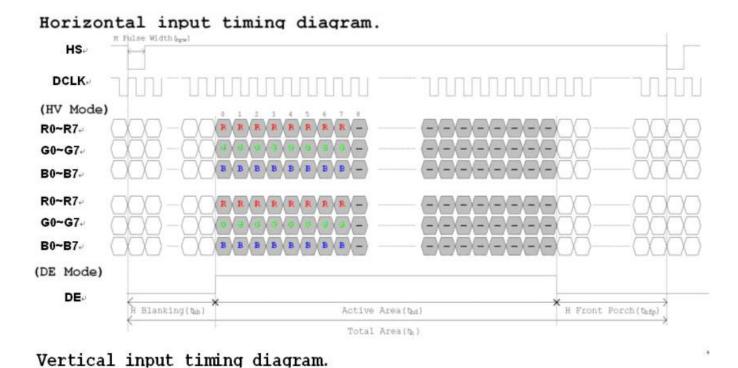
(3) Output loading condition :





| Horizontal Input Timing | | | | | | | | | | |
|-------------------------|----------|------------------|------|-------|------|-------|--|--|--|--|
| | | Complexed | | Value | | Linit | | | | |
| Paramet | er | Symbol | Min. | Тур. | Max. | Unit | | | | |
| Horizontal disp | lay area | t _{HD} | | 800 | - | CLKIN | | | | |
| CLKIN frequ | Jency | fclk | | 33.3 | 50 | MHz | | | | |
| 1 Horizontal lin | e period | t | 862 | 1056 | 1200 | CLKIN | | | | |
| | Min. | | | 1 | | CLKIN | | | | |
| HSD pulse width | Typ. | t _{HPW} | | | | CLKIN | | | | |
| width | Max. | | | 40 | | CLKIN | | | | |
| HSD back porch | SYNC | t _{HBP} | 46 | 46 | 46 | CLKIN | | | | |
| HSD front porch | SYNC | t _{HFP} | 16 | 210 | 354 | CLKIN | | | | |

| Vertical Input Timing | | | | | | | | | |
|-----------------------|------------------|------|-------|------|------|--|--|--|--|
| Parameter | Symbol | | Value | | Unit | | | | |
| Farameter | Symbol | Min. | Тур. | Max. | Unit | | | | |
| Vertical display area | t _{vp} | | 480 | | HSD | | | | |
| VSD period time | tv | 510 | 525 | 650 | HSD | | | | |
| VSD pulse width | t _{vPW} | 1 | | 20 | HSD | | | | |
| VSD back porch | t _{vBP} | 23 | 23 | 23 | HSD | | | | |
| VSD front porch | t _{vrP} | 7 | 22 | 147 | HSD | | | | |



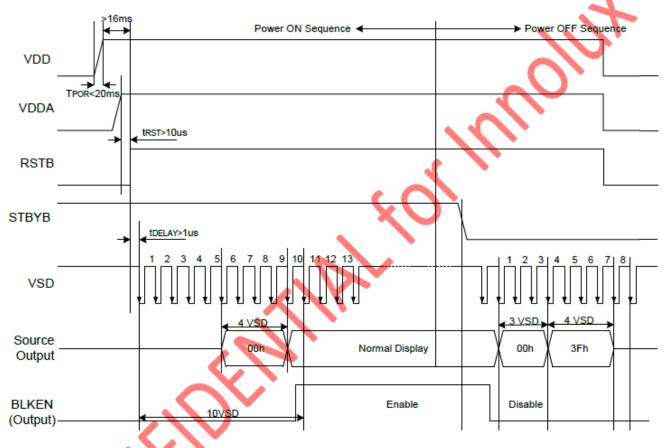
typw VS. HS. DE tyb tyfp tvd tv

10. POWER SEQUENCE

To prevent the device damage from latch up, the power ON/OFF sequence shown below must be followed.

Power ON: VDD, DGND \rightarrow VDDA, AGND \rightarrow V1 to V14 Power OFF: V1 to V14 \rightarrow VDDA, AGND \rightarrow VDD, DGND

In order to prevent ILI6122 from power ON reset fail, the rising time (t_{POR}) of the digital power supply VDD should be maintained within given specifications. The power ON/OFF timing sequence is illustrated as below:



Note: For prevent anormal operation, t_{RST} must be longer than 10us during Power ON sequence.

11. RELIABILITY TEST CONDITIONS

| No. | Test item | Test condition | Inspection after test |
|------|----------------------------|--|--|
| 11.1 | High temperature storage | 80±2°C/240 hours | |
| 11.2 | Low temperature storage | -30±2°C/240 hours | |
| 11.3 | High temperature operating | 70±2°C/120 hours | Inspection after 2~4hours storage at |
| 11.4 | Low temperature operating | -20±2°C/120 hours | room temperature, the sample shall be free |
| 11.5 | Temperature cycle | -20±2°C~25°C~70±2°C*10cycles (30min.) (5min.) (30min.) | from defects : 1.Current changing |
| 11.6 | Damp proof test | 50°C*90% RH/120 hours | value before test and after test is 50% larger; |
| 11.7 | Vibration test | Frequency : 10Hz~55Hz~10Hz Amplitude : 1.5mm , X , Y , Z direction for total 3hours (Packing condition) | 2. Function defect : Non-display,abnormal-di splay,missing lines, Short lines,ITO corrosion; 3. Visual defect : Air |
| 11.8 | Dropping test | Drop to the ground from 1m height, one time, every side of carton. (Packing condition) | bubble in the LCD,Seal leak,Glass crack. |
| 11.9 | ESD test | Voltage : $\pm 8KV$ R : 330Ω C : $150pF$ Air discharge, $10time$ | |

Remark :

1. The test samples should be applied to only one test item.

2.Sample size for each test item is 3~5pcs.

3.For damp proof test, Pure water(Resistance>10M Ω) should be used.

4.In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judged as a good part.

5.EL evaluation should be excepted from reliability test with humidity and temperature: Some defects such as black spot/blemish can happen by natural chemical reaction with humidity and Fluorescence EL has. 6.Failure judgment criterion: Basic specification, Electrical characteristic, Mechanical characteristic, Optical characteristic.

12. INSPECTION CRITERION

12.1 Objective

The TFT test criterion are set to formalize TFT quality standards for ODNA with reference to those of the customer for inspection, release and acceptance of finished TFT products in order to guarantee the quality of TFT products required by the customer.

12.2. Scope

The criterion is applicable to all the TFT products manufactured by ODNA.

12.3. Equipment for Inspection

Electrical tester, electrical testing machines, vernier calipers, microscopes, magnifiers, anti-static wrist straps, finger cots, labels, tri-phase cold and hot shock machine, constant temperature and humidity chamber, backlight table, ovens for high-low temperature experiments, refrigerators, constant voltage power supply (DC), desk Lamps, etc.

12.4. Sampling Plan and Reference Standards

12.4.1 Sampling plan :

Refer to National Standard GB/T 2828.1---2012/ISO2859-1:1999, level II of normal levels :

Major defect: AQL 0.4

Minor defect: AQL 1.0

12.4.2 GB/T 2828.1---2012/ISO2859-1:1999 Sampling check procedure in count

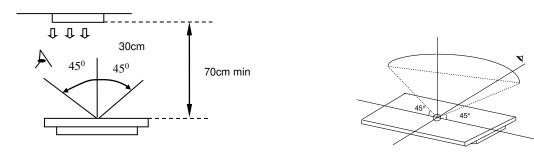
12.4.3 GB/T 18910. Standard for LCM parts

12.4.4 GB/T24213-2008 Basic Environmental Test Procedures for Electrical and Electronic Products 12.4.5 IPC-A-610E Acceptability of Electronic Assemblies

12.5. Inspection Conditions and Inspection Reference

12.5.1 Cosmetic inspection: shall be done normally at 23±5°C of the ambient temperature and 45~75%RH of relative humidity, under the ambient luminance between 500lux~1000lux and at the distance of 30cm apart between the inspector's eyes and the LCD panel and normally in reflected light. For backlight LCM, cosmetic inspection shall be done under the ambient luminance less than 100lux with the backlight on.

12.5.2 The TFT shall be tested at the angle of 45°left and right and 0-45° top and bottom as the following picture showing:



12.5.3 Definition of viewing area(VA)

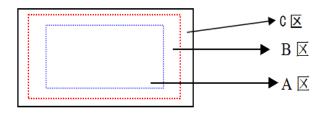
A area : Active area(AA area)

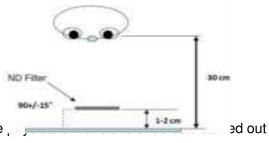
B area : Viewing area(VA area)

C area : Non-viewing area(not viewing after customer assembly)

If there is any appearance viewing defect which do not affect product quality and customer assembly in C area, it's accepted in generally.

The criteria apply to A and B area except chipping and crack.





12.5.4 Inspection with naked eyes(exclusive of the inspection of the , with magnifiers)12.5.5 ND card use instruction

AFY800480B0-5.0N12NTM-R

12.5.6 Undefined items or other special items, refer to mutual agreement and limited sample. If criterion does not match product specifications/ technical requirement, both should be subject to special inspection criterion agreed by customer.

12.6. Defects and Acceptance Standards

12.6.1 Electrical properties test

12.6.1.1 Test voltage(V) : Refer to the instruction of testers and the product specification or drawing and the display content and parameters and display effects shall conform to the product specification and drawing. 12.6.1.2 Current Consumption(I) : Refer to approved product specifications or drawings.

| No. | Defects | Descriptions | Pictures | Inspection method/tools | Defect category |
|-------------|----------------------------------|--|------------------|---------------------------------------|--------------------|
| 12.6.1.3.1 | No display /reaction | shows no picture/display in normal connected situation. | | Naked eyes/ testers | MA. |
| 12.6.1.3.2 | Missing segment | Shows missing lines in normal display | | Naked eyes/ testers | MA. |
| 12.6.1.3.3 | Sealing Defect | Shows defect in any display around LCD liquid crystal sealant area | | Naked eyes/ testers | MA. |
| 12.6.1.3.4 | POL angle defect | Not accepted | 正带 POL贴反180度后 | Naked eyes/ testers | MA. |
| 12.6.1.3.5 | Image retention (sticking) | The previous picture stays in the next picture.Disappear time <10s, OK; time>10s, NG | | Naked eyes/ testers | MA. |
| 12.6.1.3.6 | Flicker | Not accepted | | Naked eyes/ testers | MA. |
| 12.6.1.3.7 | Display abnormal | Not accepted | | Naked eyes/ testers | MA. |
| 12.6.1.3.8 | Cross-talk | Refer to limited sample | • | Naked eyes/ limited sample | MA. |
| 12.6.1.3.9 | Display dim/bright | Refer to limited sample | / | Naked eyes/ limited sample | MA. |
| 12.6.1.3.10 | Contrast | Refer to limited sample | / | Naked eyes/ limited sample | MA. |
| 12.6.1.3.11 | Huge current | Out of spec, not accepted | / | Ammeter | MA. |
| 12.6.1.3.12 | TP function defect | Not accepted | / | Naked eyes/ Touch/ test program | MA. |

12.6.1.3 Function items(Defect category : MA.)

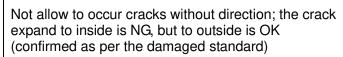
12.6.2 LCD dot/line defect 12.6.2.1 LCD pixel dot defect(defect category : MI.)

| | Item | | | | Inspe | ctio | on criterior | า | | | |
|------------------|---------------------------|------------|--|--------------|----------------|--------------|---------------|------------------|--------------------------|--|--|
| | Size | | S< | <5" | | | <10" | | S<15" | | |
| Color pixel dot | t defect(RG | B dot) | 1 | 1 | | 2 | | | 2 | | |
| 2 connected b | right dot | | (|) | | 1 | | | 1 | | |
| 3 connected b | right dot or | more | 0 | | | 0 | | | 1 | | |
| Bright dot qua | ntity | | 1 | | | 2 | | | 3 | | |
| Random dark | dot quantity | ' | 2 | 2 | | 3 | | | 4 | | |
| 2 connected d | ark dot | | 1 | 1 | | 1 | | | 2 | | |
| 3 connected d | ark dot or n | nore | (|) | | 0 | | | 0 | | |
| Dark dot quan | tity | | 3 | 3 | | 4 | | | 5 | | |
| Multi-bright do | t | | | | ND 3 | 3%ł | nidden, OK | | | | |
| Remark: 2 brig | ght dots dist | ance DS≥ | :15mm 2 | dark dots | distance D | S≥ | 5mm | | | | |
| 1) Bright dot: F | Power on Th | T and RC | GB dot in b | olack displa | ay | | | | | | |
| 2) Dark dot: Po | ower on TF | T and gray | y or black | dot in RGE | 3 display | | | | | | |
| 3) Multi-bright | dot: Power | on TFT ar | nd fluores | cent tiny do | ot in black o | disp | olay(only vis | sible in black o | display) | | |
| 12.6.2.2 LCD a | appearance | dot defec | | | | | | | | | |
| No. | Item | | | spection c | | | 011 40 4 51 | Picture | Inspection | | |
| | | _ | ze | S<5" | 5"≤S<10" | | 0"≤S<15" | | method/tools | | |
| | | | | | Not count | | 0≤0.2mm | | | | |
| | | | D≤0.25 | 3 | 3 | | Not count | | Naked eyes | | |
| | Deteleteet | | D≤0.30 | 1 | 2 | | 2~0.35mm | | /film card /magnifier | | |
| 12.6.2.2.1 | Dot defect | | D≤0.35 | 0 | 1 | | Q'ty ≤ 4 | D=(a+b)/2 | | | |
| 12.0.2.2.1 | (black dot, white dot) | | D≤0.50 | 0 | 0 | | 1 | | | | |
| | write dot) | | >0.5 | | | | bulk is not | accented | | | |
| | | | t quantity≤ | | 111.101011-001 | . as | | accepted. | | | |
| | | | | | 1 cm is iuda | har | l as multi-do | ht | | | |
| | | Length | Width | | | | | | | | |
| | | | | (mm) | (mm) | S<5" | 5"≤S<10" | 1 | 0"≤S<15" | | |
| | | Not | . , | | | | | 10 | | | |
| | | count | W≤0.03 | Accepted | Accepted | / | Accepted | | | | |
| | | 1.15 | 0.03≤W | | • | | | 1 | Naked eyes | | |
| | Line | L≤5 | <0.05 | 3 | 3 | | Not count | | /film card | | |
| | defect | 1.45 | 0.05≤W | 0 | 4 | | 3 | | /magnifier | | |
| 12.6.2.2.2 | (visible | L≤5 | <0.08 | 0 | 1 | | 3 |) - | | | |
| | when | L≤8 | 0.05≤W | 0 | 0 | | 1 | | | | |
| | power on) | L30 | <0.08 | 0 | 0 | | I | | | | |
| | | L>8 | W>0.08 | 0 | | | | 2.7 | | | |
| | | Remark : | | | | | | | | | |
| | | | • | - | • | | | jainst light, sh | | | |
| | | | k/folding/s | scratch but | can not be | e toi | uched, no c | ontrol or refe | to keeping | | |
| | | sample. | | | | | | | | | |
| | Polarizer | | e(mm) | S<5" | 5"≤S<10 | | 10"≤S<15 | | | | |
| | convex- | | 0.20 | Not coun | | Int Not coun | | t | | | |
| 40.0000 | concave | | <d≤0.5< td=""><td>2</td><td>2</td><td></td><td>3</td><td></td><td>Naked eyes</td></d≤0.5<> | 2 | 2 | | 3 | | Naked eyes | | |
| 12.6.2.2.3 | dot defect, polarizer | | <d≤0.8< td=""><td>0</td><td>1</td><td></td><td></td><td>1</td><td>/film card /magnifier</td></d≤0.8<> | 0 | 1 | | | 1 | /film card /magnifier | | |
| | bubble | 0.8< | :D≤1.5 | 0 | 0 | | 1 | 1 ← a→ /ma | | | |
| | defect | D>1 | .5mm | 0 | 0 | | 0 | | | | |
| | 401001 | | | | | | | | | | |

12.6.3 Chipping defect

| No. | Item | | Accepte | d criterion(mm) | | MA. | MI. |
|----------|--|---|------------------------------|---|---|-----|--------------|
| 12.6.3.1 | ITO conductive side | Х | / | ≤1/8L | / | | |
| | | Y | Y≤1/6W | 1/6W <y≤1 4w<="" td=""><td>1/4W <y< td=""><td></td><td>,</td></y<></td></y≤1> | 1/4W <y< td=""><td></td><td>,</td></y<> | | , |
| | TITE A | Accept | 2 | 2 | 0 | | V |
| | | | | [| 1 | | |
| | Corner chipping | Х | / | ≤1/6L | / | | |
| | (ITO pins position) | Y | Y≤1/2W | 1/2W <y≤w< td=""><td>W <y< td=""><td></td><td>v</td></y<></td></y≤w<> | W <y< td=""><td></td><td>v</td></y<> | | v |
| 12.6.3.2 | | Accept | 2 | 1 | 0 | | |
| | | per 6.3.3; a black borde | at the same er of the fra | ed in sealed edge time it should no ame and the corn ection position per | t enter into er chipping | | |
| | Chipping in sealed area (outside chipping) | Х | / | ≤1/8L | / | | |
| | | Y(outside chipping) | Not enter into | Enter Y≤H | H <y< td=""><td></td><td></td></y<> | | |
| | | Y(inside chipping) | sealant | Enter Y≤1/2H | 1/2H <y< td=""><td></td><td></td></y<> | | |
| 12.6.3.3 | | Z | ≤T | ≤1/2T | / | | \checkmark |
| | | Accept | 2 | 1 | 0 | | |
| | Chipping in sealed area (inside chipping) | The standards of inner and outer chipping on edge sealing area are same. When the chipping occurred in the opposite of stage, Y as per the chipping on the non-conduction side standard in 6.3.1 | | | | | |
| | Conductive side (back side chipping) | х | / | ≤1/6L | / | | |
| | | Y | Y≤1/3W | 1/3W <y≤2 3w<="" td=""><td>2/3W <y< td=""><td></td><td></td></y<></td></y≤2> | 2/3W <y< td=""><td></td><td></td></y<> | | |
| 12.6.3.4 | | Accept | 2 | 2 | 0 | | |
| | ` \ x*\ | Chipping into ITO side, refer to 6.3.1 | | | | | |
| | Protruding LCD poor cutting and LCD burrs | х | / | ≤1/8L | / | | |
| | | Y | ≤1/6W | 1/6W <y≤1 5w<="" td=""><td>1/5W <y< td=""><td></td><td></td></y<></td></y≤1> | 1/5W <y< td=""><td></td><td></td></y<> | | |
| 12.6.3.5 | t b | | | / | / | | Y |
| | | Accept | 1 | 1 | 1 | | |
| | | The outside drawing. | e protruding | control as per the | tolerance of | | |

| | Crac | k |
|----------|------|---|
| 12.6.3.6 | | |



Remark :

X means the length of chipping;

Y means the width;

Z means the thickness;

W means the step width of the two glasses;

H means the distance from the glass edge to the sealant inner edge;

T means glass thickness.

12.6.4 Backlight components

| No. | Item | Description | Accepted criterion | MA. | MI. |
|----------|-----------------------------|---|--------------------------------|--------------|--------------|
| 12.6.4.1 | No backlight wrong Color | / | Rejected | \checkmark | |
| 12.6.4.2 | Color deviation | When powered on, the LCD color differs from its sample and found that the color not conforming to the drawing after testing. | Refer to sample and drawing | | \checkmark |
| 12.6.4.3 | Brightness deviation | When powered on, the LCD brightness differs from its sample and is found after testing not conforming to the drawing; or if it conforms to the drawing but the brightness over $\pm 40\%$ than its typical value. | Refer to sample and drawing | | |
| 12.6.4.4 | Uneven brightness | Uneven on the same LCD and out of the specification of the drawing. The no specification evenness= (the max value-the min value)/ mean value< 70%. | Refer to sample and drawing | | \checkmark |
| 12.6.4.5 | Spot/line/ scratch | When power on, it has dirty spot, scratches and so on spot and line defects. | Refer to 6.2.2 | | |

12.6.5 Metal frame (Metal Bezel)

| No. | Item | Description | Accepted criterion | MA. | MI. |
|----------|---|--|--------------------|--------------|--------------|
| 12.6.5.1 | Material & surface treatment | Metal frame/surface treatment do not conform to the specifications. | Rejected | \checkmark | |
| 12.6.5.2 | Tab twist Unconformity /Tab not twisted | Wrong twist method or direction and twist tabs are not twisted as required. | Rejected | \checkmark | |
| 12.6.5.3 | Bezel paint loss | 1.Front surface : Paint peel off and scratch to the | | | \checkmark |
| 12.6.5.4 | Bezel scratch | bottom Dot:D≤0.5mm, exceeds 3; | | | \checkmark |
| 12.6.5.5 | Painting peel off, discoloration, dent, and scratch | Line:L≤3.0mm,W≤0.05mm exceeds 2; 2.Front dent, air bubble and side with paint peeling off scratch to the bottom Dot: D≤1.0mm, exceeds 3; Line:L≤3.0mm,W≤0.05mm, exceeds 2; | Rejected | | \checkmark |

| 12.6.5.6 | Burr | Burr(s) on metal bezel is so long as to get into viewing area. | Rejected | | \checkmark |
|------------|--------------------------------|--|--|--------------|--------------|
| 12.6.6 FPC | | | | | |
| No. | Item | Description | Accepted criterion | MA. | MI. |
| 12.6.6.1 | Model &P/N | Material model & P/N | Keep the same with drawing and technical requirement | \checkmark | |
| 12.6.6.2 | Dimension/ position | Dimension in drawing spec | f≤1/3w, h ≤1/3H, dimension in drawing spec-> OK Conducive material and ITO/PDA connective area must over than 1/2. Entire dimension must be in spec tolerance. | | \checkmark |
| 12.6.6.3 | FPC appearance | Hot pressing material get broken, folding line open; FPC golden finger oxidate, broken ,scratch ,foreign material which cause line short | Broken length<2mm; FPC line is OK- > Accepted Crack and line broken->Rejected | | \checkmark |
| 12.6.6.4 | FPC burr | Burr near FPC edge area | When cover line and burr length ≤1.0mm->Accepted | | \checkmark |
| 12.6.6.5 | FPC falling off | FPC bonding area falling off ; silica gel breaking | Rejected | | \checkmark |
| 11.6.6.6 | Sealant missing ITO line | Sealant is not covered all ITO line | Rejected | \checkmark | |
| 12.6.6.7 | Missing sealant | No sealant | Rejected | \checkmark | |
| 12.6.6.8 | Sealant | Sealant height ->product total height | Rejected | \checkmark | |
| 12.6.7 SMT | | | | | |
| No. | Item | Description | Accepted criterion | MA. | MI. |
| 12.6.7.1 | Soldering bridge | Solder between adjacent pads and components | Rejected | | Ż |

| 12.6.7.2 | Solder ball/splash | Solder ball/tin dross causing short circuit at the solder point. There are active solder ball and splash. | Rejected | | \checkmark |
|---------------|---------------------------------|--|---|--------------|--------------|
| 12.6.7.3 | Soldering excursion | Soldering slant > 1/3 soldering pad | Rejected | | V |
| 12.6.7.4 | Component wrong | Component on PCB differs with drawing: wrong one, extra one,lack one,opposite polarity | Rejected | \checkmark | |
| | attaching | JUMP short circuit on PCB: extra soldering ,lack soldering. | Rejected | \checkmark | |
| 12.6.7.5 | Component falling off | Soldering but component is missing | Rejected | \checkmark | |
| 11.6.7.6 | Wrong component | Component model/spec differs from product specification | Rejected | \checkmark | |
| 12.6.8 Genera | Appearance | | | | |
| No. | Item | Description | Accepted criterion | MA. | MI. |
| 12.6.8.1 | Dimension | According to drawing | Accepted | \checkmark | |
| 12.6.8.2 | Surface stain | Defect mark or label are not removed residual glue, and finger print,etc; | Rejected | | \checkmark |
| 12.6.8.3 | Assembly foreign material | Dot/linear stain after assembly backlight and diffuse film TP assembly fogy stain | Invisible when power on->OK Refer to 6.2.2 dot/line spec | | \checkmark |
| 12.6.8.4 | Mixture | Different model product in the same shipment | Rejected | \checkmark | |
| 12.6.8.5 | Product mark | Missing, unclear, incorrect, or misplaced part | Rejected | | \checkmark |
| 12.6.8.6 | Componen t mark | Silk screen mark clear, resistance measured value in spec | Accepted (Refer to customer special requirement) | | \checkmark |
| 12.6.8.7 | Newton's rings | Area<1/6 screen area quantity≤1 | Accepted | | \checkmark |
| 12.6.8.8 | Mura | 1.In black display ND 3% invisible ->OK; visible->NG 2.Naked eyes inspection RGB display invisible Black display, area<1/4 screen area | Refer to limited sample | | V |

| 12.6.8.9 | Light leak | 1.LCD edge(near backlight) shadow by LCD lamps irregular illuminate 2.Judge in black/white/gray display (slight leaky is yellowish,greenish, blueish ->NG); Tape 浮起漏光 Panel 倒邊漏光 | Refer to limited sample | \checkmark |
|-----------|------------|--|-------------------------|--------------|
| 12.6.8.10 | Polarizer | 1.Polarizer slant.Cover VA and not over LCD edge 2.No unmovable stain or finger print in polarizer VA 3.Bubble/warped but not enter VA | Accepted | \checkmark |
| 12.6.8.11 | TP defect | 1.TP crack 2.TP stain(fogy& unremovable) 3.TP glue overflow to VA | Rejected | V |

Remark :

Anything which is not clearly defined in 6.5~6.8 should refer to IPC-A-610E.Consumer Electronics, Non-consumer Electronics refer to Igrade and Industrial, Automobile refer to Igrade.

12.7 Others

Items not specified in this document or released on compromise should be inspected with reference to mutual agreement and limit samples.

13. HANDLING PRECAUTIONS

13.1 Mounting method

The LCD module consists of two thin glass plates with polarizes which easily be damaged. And since the module in so constructed as to be fixed by utilizing fitting holes in the printed circuit board. Extreme care should be needed when handling the LCD modules.

13.2 Caution of LCD handling and cleaning

When cleaning the display surface, Use soft cloth with solvent

[recommended below] and wipe lightly :

- •.lsopropyl alcohol
- Ethyl alcohol

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface. Do not use the following solvent :

•.Water

Aromatics

Do not wipe ITO pad area with the dry or hard materials that will damage the ITO patterns Do not use the following solvent on the pad or prevent it from being contaminated :

- Soldering flux
- •.Chlorine (CI) , Sulfur (S)

If goods were sent without being silicon coated on the pad, ITO patterns could be damaged due to the corrosion as time goes on.

If ITO corrosion happen by miss-handling or using some materials such as Chlorine (CI), Sulfur (S) from customer, Responsibility is on customer.

13.3 Caution against static charge

The LCD module use C-MOS LSI drivers, so we recommended that you :

Connect any unused input terminal to Vdd or Vss, do not input any signals before power is turned on, and ground your body, work/assembly areas, assembly equipment to protect against static electricity.

13.4 Packing

Module employ LCD elements and must be treated as such.

• Avoid intense shock and falls from a height.

•. To prevent modules from degradation, do not operate or store them exposed direct to sunshine or high temperature/humidity.

13.5 Caution for operation

•. It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life.

•. An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.

•.Response time will be extremely delayed at lower temperature then the operating temperature range and on the other hand at higher temperature LCD's how dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operation temperature.

•. If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.

•.A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit.

•.Usage under the maximum operating temperature, 50%Rh or less is required.

•.When fixed patterns are displayed for a long time, remnant image is likely to occur.

13.6 Storage

In the case of storing for a long period of time for instance, for years for the purpose or replacement use, the following ways are recommended.

•.Storing in an ambient temperature 10°C to 30°C, and in a relative humidity of 45% to 75%. Don't expose to sunlight or fluorescent light.

•.Storing in a polyethylene bag with the opening sealed so as not to enter fresh air outside in it . And with no desiccant.

•.Placing in a dark place where neither exposure to direct sunlight nor light's keeping the storage temperature range.

•.Storing with no touch on polarizer surface by the anything else.

It is recommended to store them as they have been contained in the inner container at the time of delivery from us.

13.7 Safety

•. It is recommendable to crash damaged or unnecessary LCD's into pieces and wash off liquid crystal by either of solvents such as acetone and ethanol, which should be burned up later.

•. When any liquid leaked out of a damaged glass cell comes in contact with your hands, please wash it off well with soap and water.

14. PRECAUTION FOR USE

14.1 A limit sample should be provided by the both parties on an occasion when the both parties agreed its necessity. Judgment by a limit sample shall take effect after the limit sample has been established and confirmed by the both parties.

14.2 On the following occasions, the handing of problem should be decided through discussion and agreement between responsible of the both parties.

•.When a question is arisen in this specification.

•.When a new problem is arisen which is not specified in this specifications.

•.When an inspection specifications change or operating condition change in customer is reported to ODNA, and some problem is arisen in this specification due to the change.

•.When a new problem is arisen at the customer's operating set for sample evaluation in the customer site.

15. PACKING SPECIFICATION

Please consult our technical department for detail information.